

AMENDMENTS TO THE SPECIFICATION

Please replace the first paragraph on page 2 of the specification, under Related Application, with the following rewritten paragraph.

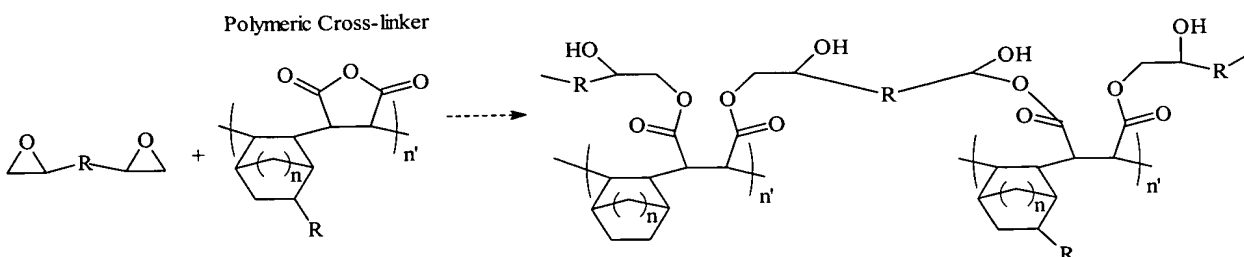
Related Application

This application is a Divisional of Patent Application No. 10/028,393 filed on December 21, 2001, now U.S. Patent No. 6,620,512.

Please replace paragraph [011] beginning on page 5 with the following rewritten paragraph:

[011] The curing agents comprise polyfunctional, low molecular weight anhydride polymers and/or oligomers. In accordance with an embodiment of this invention, the curing agents may include these polymers and/or oligomers in combination with other compounds. The polymers and/or oligomers may be present in the curable underfill material composition in an amount of from about 5 to about 25 weight percent based on total weight of the resin and catalysts. Preferred curing agents include olefin/maleic anhydride copolymers, such as, styrene/maleic anhydride, cyclohexane/maleic anhydride, norbornene/maleic anhydride copolymers. By way of example, the following chemical schematic shows a low-cost, low molecular weight ~~polymeric~~ polymeric cross-linker that may be used in an underfill composition:

Scheme 1



where n is 0 to 3, n' is 5 to 50, and R is selected from the group consisting of alkyl, aryl, substituted aryls, esters, ethers, lactones, anhydrides, alcohols, nitriles, epoxy, and mixtures thereof.